

# LMR45 Series Low Resistance Metal Strip Chip Resistors



#### Description

- Welded construction product
- Resistance range: 1~200mR
- Rated power: 4~5W
- Low inductance design
- Alloy Material, Shock Resistance
- Operating temperature range: 65°C~170°C

#### Applications

- Current sensing application
- Over current protection
- Servo motor control circuits
- Inverter power
- Electric control system
- Li-battery management system

## Part number

LMR	45	F	5P0	R005	
【1】	[2]	[3]	[4]	[5]	

[1] Series Name: Low resistence Metal strip Chip Resistors

- [2] Chip size: 45:4527
- [3] Resistance Precision: D:±0.5% ; F:±1% ; G:±2% ; J:±5%
- [4] Power Rating: 5P0=5W ; 4P0=4W
- [5] Resistance Code: R005:  $5m\Omega$  ; R050:  $50m\Omega$

## **Standard Electrical Specifications**

Size	Power (W) <sub>(70℃)</sub>	Resistance/mΩ ±0.5%, ±1%, ±2%, ±5%	TCR (ppm/℃)	Material	Operating Temperature (℃)	
4527	F	1 ~ 3	±75	Mangapin		
	D	4 ~100	150	Manganin	-65℃~170℃	
	4 101 ~200		TOO	Kamar		

Note: (1) Products of differentsizes are being verified by power rating tests at other ambient temperatures.



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#### **Products & Recommend Pad Dimension**

1.1	l mit ·	mm
U	μ <u>π</u> ι.	111111

Туре	Resistance	W±0.2	C±0.2	A±0.2	D±0.1	L	а	С
4527	1 ~ 200	11.6	6.9	2.0	1.0	7.0	3.4	8.7

Welded Construction



Silicone coating with laser marking

- Ni plated & Sn
- Cu terminal
- Welding seam
- Resistance alloy

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#### **Power Derating Curve**

For resistors operated in ambient temperatures 70°C, power rating shall be derated inaccording with the curve below:



# **Recommended Solder Curve**



Reflow Condition		Pb – Free assembly			
	- Temperature Min (Ts(min))	150°C			
Pre heat	- Temperature Max (Ts(max))	200°C			
	- Time (Min to Max) (ts)	60 – 120 secs			
م Liqı(Liqı	Verage ramp up rate uidus Temp (TL) to peak	5°C/second max			
TS(r	nax) to TL - Ramp-up Rate	5°C/second max			
Reflow	- Temperature (TL) (Liquidus)	217°C			
	- Temperature (tL)	60 – 150 seconds			
F	Peak Temperature (TP)	260°C			
Time within 5	°C of actual peak Temperature (tp)	20 – 40 seconds			
	Ramp-down Rate	5°C/second max			
Time 2	5°C to peak Temperature (TP)	8 minutes Max.			
	Wave Soldering	260°C, 10 seconds max.			
	Hand Soldering	350°C, 5 seconds max.			

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# **Product Characteristics**

Item	Additional Requirements	Limited	Reference
Temperature Cycling	1000 Cycles (-55℃ to +150℃)	±0.5%	JESD22 Method JA-104
High Temperature Exposure	100hrs.@T=170℃.Unpowered.	±0.5%	MIL-STD-202 Method 108
Moisture Resistance	t=24hrs/cycle.Note: Steps 7a & 7b not required. Unpowered.	±0.5%	MIL-STD-202 Method 106
Biased Humidity	1000hrs 85°C/85%RH。Note: Specified	10 50/	MIL-STD-202
Diased Fluthidity	conditions:10% of operating power.	±0.5%	Method 103
Operational Life	Condition D Steady State TA=125°C at rated power.	±0.5%	MIL-STD-202 Method 108
Thermal Shock	1000X(-55°C to +150°C)	0.5%	MIL-STD-202Met hod107G
Solderability	235℃±5℃,2s±0.5s	95% Coverage Minimum	J-STD-202
Resistance to Soldering Heat	260℃±5℃, 10s±1s	±0.5%	MIL-STD-202 Method 210
Short Time Overload	4×Rated power for 5 s	±0.5%	MIL-STD-202 Method 201
Shock	100g , 6ms , axes Z and Y , 10 Shocks per axis	0.5%	MIL-STD-202 Method 213
VIBRATION	(10 - 2000 HZ) , 20g @0.1ms	0.5%	MIL-STD-202Met hod204



# LMR45 Series Low Resistance Metal Strip Chip Resistors

# Tapping & Package



Storage Conditions: Temperature:5°C~35°C, Humidity:40%~75%

Embossed Plastic Tape

Туре	Pack	<b>A</b> ±0.2	<b>B</b> ±0.2	<b>D0</b> +0.5-0	<b>E</b> ±0.1	<b>F</b> ±0.05	<b>P0</b> ±0.1	<b>P1</b> ±0.1	<b>P2</b> ±0.1	<b>W</b> ±0.2	<b>D1</b> ±0.05	<b>t</b> ±0.15
4527	Emboss	7.40	11.80	1.50	1.75	11.50	4.00	12.0	2.00	24.00	1.50	2.30

## Packaging

Quantity: 3.000pcs

#### Storage

- The temperature condition must be controlled at 25±5℃, The R.H. must be controlled at 60±15% Store in accordance with this requirement, and the validity period is two years after the date of manufacture.
- 2. Please avoid the mentioned harsh environment below when storing to ensure product performance and its' weldability. Places exposed to sea breeze or other corrosive gas, such as Cl2、H2S、NH3、SO2 and NO2.
- 3. When the product is moved and stored, please ensure the correct orientation of the box.Do not drop or squeeze the box. Otherwise, the electrode or the body of the product may be damaged.